

### **MOSFET**

### OptiMOS<sup>™</sup> 3 Power-Transistor, 120 V

#### **Features**

- N-channel, logic level
- N-chamel, logic level
  100% avalanche tested
  Excellent gate charge x RDS(on) product (FOM)
  Very low on-resistance RDS(on)
  150 °C operating temperature
  Pb-free lead plating; ROHS compliant

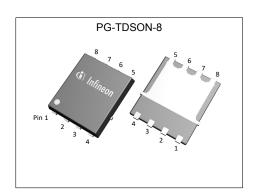
- Ideal for high-frequency switching and synchronous rectification
  Halogen-free according to IEC61249-2-21

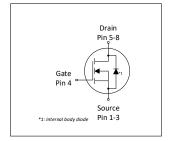
# **Product validation**

Qualified according to JEDEC Standard

Table 1 **Kev Performance Parameters** 

| Table 1 1toy 1 of formation 1 aramotore |       |      |  |  |  |  |  |
|---|-------|------|--|--|--|--|--|
| Parameter                               | Value | Unit |  |  |  |  |  |
| <b>V</b> <sub>DS</sub>                  | 120   | V    |  |  |  |  |  |
| R <sub>DS(on),max</sub>                 | 8.0   | mΩ   |  |  |  |  |  |
| I <sub>D</sub>                          | 99    | A    |  |  |  |  |  |
| Qoss                                    | 79    | nC   |  |  |  |  |  |
| Q <sub>G</sub> (0V10V)                  | 79    | nC   |  |  |  |  |  |











| Type / Ordering Code | Package    | Marking | Related Links |
|----------------------|------------|---------|---------------|
| BSC0302LS            | PG-TDSON-8 | 0302LS  | -             |

# OptiMOS<sup>™</sup> 3 Power-Transistor, 120 V BSC0302LS



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## OptiMOS<sup>™</sup> 3 Power-Transistor, 120 V BSC0302LS



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

| Parameter                                    | Ols all                           | Values      |      |                | 1114 | N   |
|--|-----------------------------------|-------------|------|----------------|------|---|
|  | Symbol                            | Min.        | Тур. | Max.           | Unit | Note / Test Condition   |
| Continuous drain current                     | I <sub>D</sub>                    | -<br>-<br>- | -    | 99<br>77<br>12 | A    | $V_{GS}$ =10 V, $T_{C}$ =25 °C<br>$V_{GS}$ =10 V, $T_{C}$ =100 °C<br>$V_{GS}$ =4.5 V, $T_{A}$ =25 °C, $R_{thJA}$ =45 °C/W <sup>1)</sup> |
| Pulsed drain current <sup>2)</sup>           | I <sub>D,pulse</sub>              | -           | -    | 394            | Α    | <i>T</i> <sub>A</sub> =25 °C  |
| Avalanche energy, single pulse <sup>3)</sup> | <b>E</b> AS                       | -           | -    | 377            | mJ   | $I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 $\Omega$  |
| Gate source voltage                          | V <sub>GS</sub>                   | -20         | -    | 20             | V    | -   |
| Power dissipation                            | P <sub>tot</sub>                  | -           | -    | 156            | W    | <i>T</i> <sub>C</sub> =25 °C  |
| Operating and storage temperature            | T <sub>j</sub> , T <sub>stg</sub> | -55         | -    | 150            | °C   | IEC climatic category; DIN IEC 68-1: 55/150/56  |

#### 2 Thermal characteristics

Table 3 Thermal characteristics

| Parameter   | Values            |      |      | Values |       | t Note / Test Condition |
|---|-------------------|------|------|--------|-------|-------------------------|
| Farailleter   | Symbol            | Min. | Тур. | Max.   | Offic | Note / Test Condition   |
| Thermal resistance, junction - case, bottom                 | R <sub>thJC</sub> | -    | 0.45 | 0.8    | °C/W  | -                       |
| Thermal resistance, junction - case, top                    | R <sub>thJC</sub> | -    | -    | 18     | °C/W  | -                       |
| Thermal resistance, junction - ambient, minimal footprint   | R <sub>thJA</sub> | -    | -    | 62     | °C/W  | -                       |
| Thermal resistance, juntion - ambient, 6 cm² cooling area²) | R <sub>thJA</sub> | -    | -    | 45     | °C/W  | -                       |

 $<sup>^{1)}</sup>$  Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.  $^{2)}$  See Diagram 3 for more detailed information  $^{3)}$  See Diagram 13 for more detailed information

# OptiMOS<sup>™</sup> 3 Power-Transistor, 120 V BSC0302LS



#### 3 Electrical characteristics

at T<sub>j</sub>=25 °C, unless otherwise specified

**Table 4** Static characteristics

| Damanatan                        | 0                    |      | Values     | S          | 1114 |   |  |
|----------------------------------|----------------------|------|------------|------------|------|---|--|
| Parameter                        | Symbol               | Min. | Тур.       | Max.       | Unit | Note / Test Condition   |  |
| Drain-source breakdown voltage   | V <sub>(BR)DSS</sub> | 120  | -          | -          | V    | V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA  |  |
| Gate threshold voltage           | V <sub>GS(th)</sub>  | 1.2  | 1.85       | 2.4        | V    | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =112 μA   |  |
| Zero gate voltage drain current  | I <sub>DSS</sub>     | -    | 0.01       | 1<br>100   | μΑ   | V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C<br>V <sub>DS</sub> =120 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C |  |
| Gate-source leakage current      | I <sub>GSS</sub>     | -    | 1          | 100        | nA   | V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V   |  |
| Drain-source on-state resistance | R <sub>DS(on)</sub>  | -    | 6.5<br>7.8 | 8.0<br>9.5 | mΩ   | V <sub>GS</sub> =10 V, I <sub>D</sub> =50 A<br>V <sub>GS</sub> =4.5 V, I <sub>D</sub> =25 A   |  |
| Gate resistance                  | R <sub>G</sub>       | -    | 0.85       | -          | Ω    | -   |  |
| Transconductance                 | $g_{fs}$             | 60   | 120        | -          | S    | $ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 50 A$  |  |

Table 5 Dynamic characteristics

| Davamatav                                  | Crossball        | Values |      |      | 11:4 | Nata / Tant Candition  |
|--|------------------|--------|------|------|------|--|
| Parameter                                  | Symbol           | Min.   | Тур. | Max. | Unit | Note / Test Condition  |
| Input capacitance <sup>1)</sup>            | Ciss             | -      | 5600 | 7400 | pF   | V <sub>GS</sub> =0 V, V <sub>DS</sub> =60 V, f=1 MHz                                     |
| Output capacitance <sup>1)</sup>           | Coss             | -      | 590  | 770  | pF   | V <sub>GS</sub> =0 V, V <sub>DS</sub> =60 V, f=1 MHz                                     |
| Reverse transfer capacitance <sup>1)</sup> | C <sub>rss</sub> | -      | 28   | 42   | pF   | V <sub>GS</sub> =0 V, V <sub>DS</sub> =60 V, <i>f</i> =1 MHz                             |
| Turn-on delay time                         | $t_{\sf d(on)}$  | -      | 11   | -    | ns   | $V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 $\Omega$ |
| Rise time                                  | t <sub>r</sub>   | -      | 9    | -    | ns   | $V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 $\Omega$ |
| Turn-off delay time                        | $t_{\sf d(off)}$ | -      | 37   | -    | ns   | $V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 $\Omega$ |
| Fall time                                  | t <sub>f</sub>   | -      | 13   | -    | ns   | $V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =25 A, $R_{\rm G,ext}$ =1.6 $\Omega$ |

Table 6 Gate charge characteristics<sup>2)</sup>

| Values               |   |  | 3   | Linit | Note / Test Condition  |
|----------------------|---|--|---|-------|--|
| Syllibol             | Min.  | Тур.   | Max.  | Ullit | Note / Test Condition  |
| Q <sub>gs</sub>      | -   | 17.5   | -   | nC    | $V_{DD}$ =60 V, $I_{D}$ =25 A, $V_{GS}$ =0 to 10 V   |
| $Q_{gd}$             | -   | 12.9   | -   | nC    | $V_{DD}$ =60 V, $I_{D}$ =25 A, $V_{GS}$ =0 to 10 V   |
| Q <sub>sw</sub>      | -   | 20.1   | -   | nC    | $V_{DD}$ =60 V, $I_{D}$ =25 A, $V_{GS}$ =0 to 10 V   |
| Qg                   | -   | 79   | -   | nC    | V <sub>DD</sub> =60 V, I <sub>D</sub> =25 A, V <sub>GS</sub> =0 to 10 V  |
| V <sub>plateau</sub> | -   | 3.1  | -   | V     | V <sub>DD</sub> =60 V, I <sub>D</sub> =25 A, V <sub>GS</sub> =0 to 10 V  |
| Qoss                 | -   | 79   | -   | nC    | V <sub>DD</sub> =60 V, V <sub>GS</sub> =0 V  |
|                      | Q <sub>gd</sub> Q <sub>sw</sub> Q <sub>g</sub> V <sub>plateau</sub> | $\begin{array}{c c} \textbf{Min.} \\ Q_{gs} & - \\ Q_{gd} & - \\ Q_{sw} & - \\ Q_{g} & - \\ \hline V_{plateau} & - \\ \end{array}$ | Min.         Typ.           Qgs         -         17.5           Qgd         -         12.9           Qsw         -         20.1           Qg         -         79           Vplateau         -         3.1 |       | Min.         Typ.         Max.           Qgs         -         17.5         -         nC           Qgd         -         12.9         -         nC           Qsw         -         20.1         -         nC           Qg         -         79         -         nC           Vplateau         -         3.1         -         V |

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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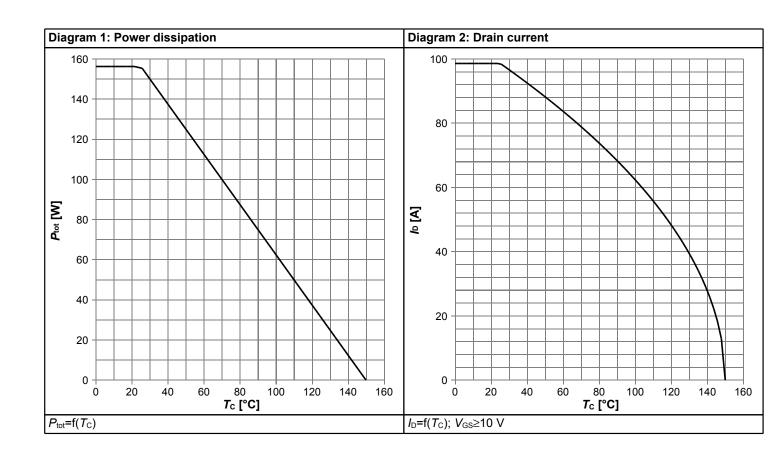


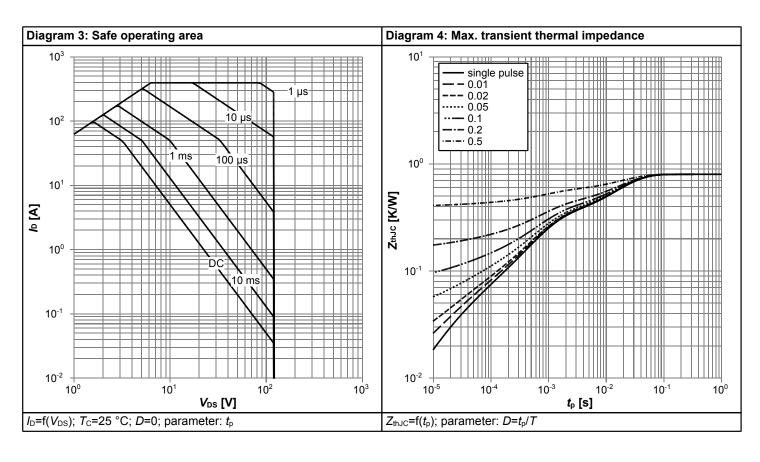
#### Table 7 Reverse diode

| Parameter                        | Cymphal                |      | Values |      |      | Note / Took Open little   |
|----------------------------------|------------------------|------|--------|------|------|---|
|                                  | Symbol                 | Min. | Тур.   | Max. | Unit | Note / Test Condition   |
| Diode continuous forward current | Is                     | -    | -      | 109  | Α    | T <sub>C</sub> =25 °C   |
| Diode pulse current              | I <sub>S,pulse</sub>   | -    | -      | 394  | Α    | T <sub>C</sub> =25 °C   |
| Diode forward voltage            | V <sub>SD</sub>        | -    | 0.88   | 1.2  | V    | V <sub>GS</sub> =0 V, I <sub>F</sub> =50 A, T <sub>j</sub> =25 °C |
| Reverse recovery time            | <i>t</i> <sub>rr</sub> | -    | 107    | -    | ns   | $V_R$ =60 V, $I_F$ =25 A, $di_F/dt$ =100 A/ $\mu$ s               |
| Reverse recovery charge          | Qrr                    | -    | 220    | -    | nC   | $V_R$ =60 V, $I_F$ =25 A, $di_F/dt$ =100 A/ $\mu$ s               |

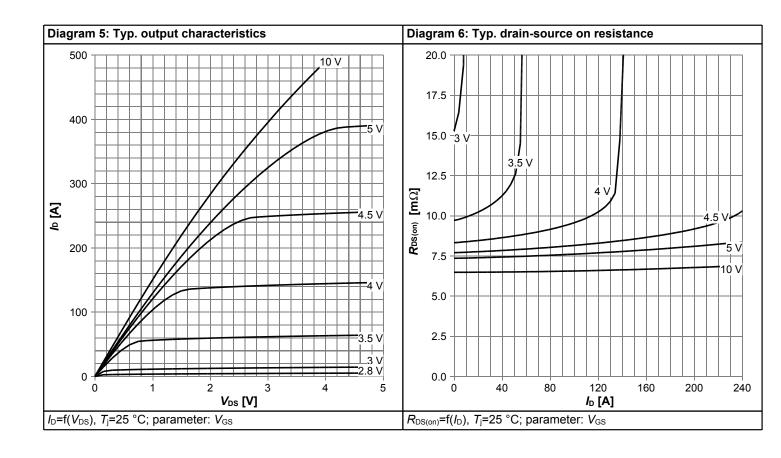


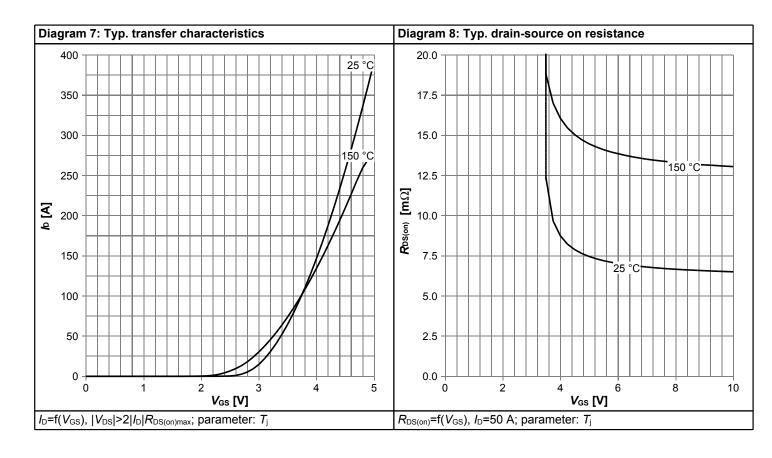
### 4 Electrical characteristics diagrams



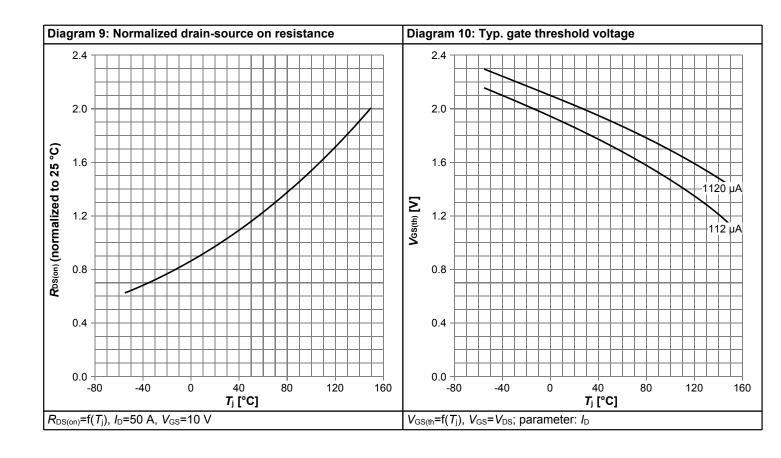


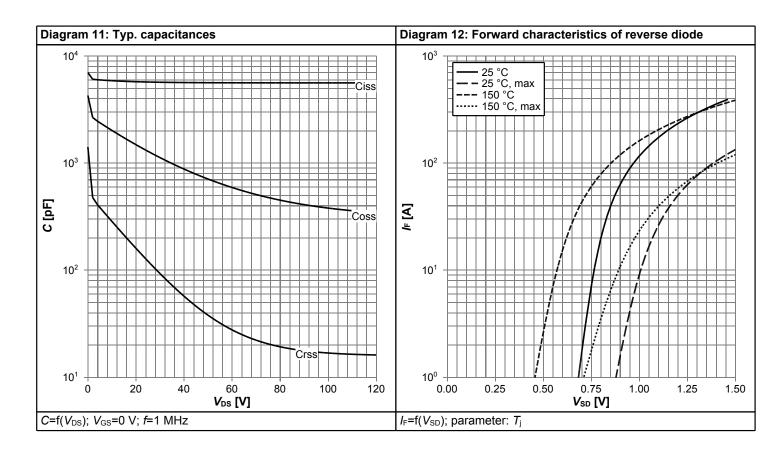




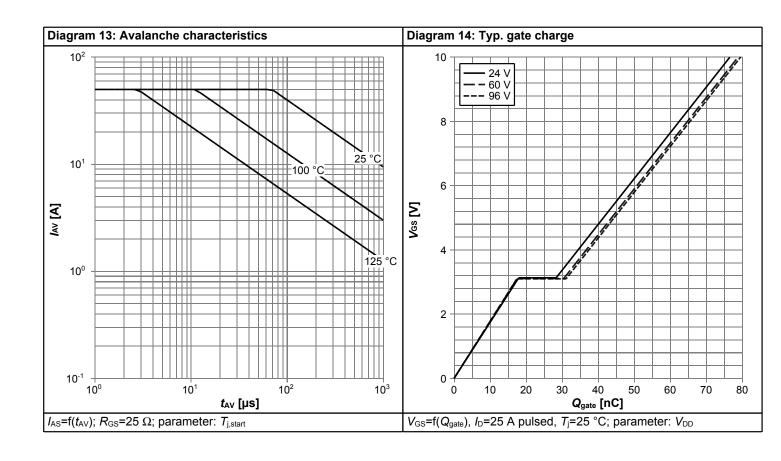


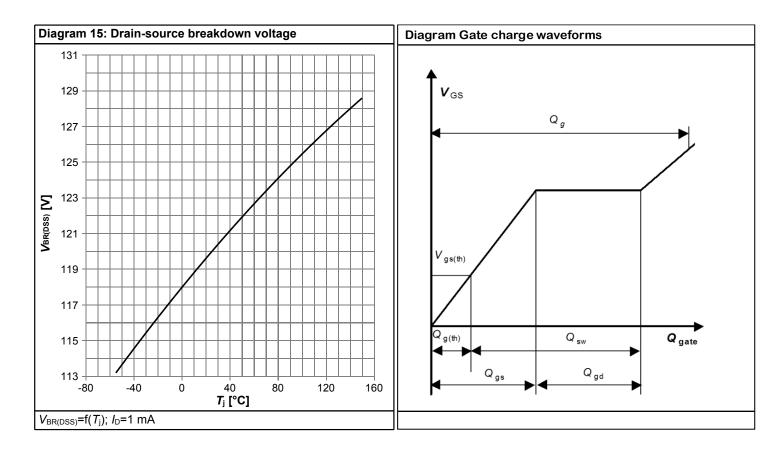






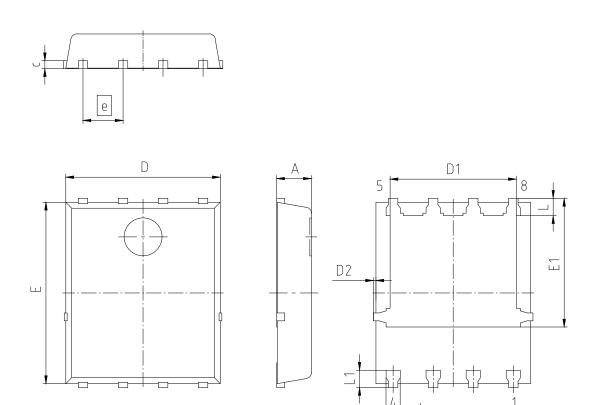








# 5 Package Outlines



| PACKAGE - GROUP<br>NUMBER: | PG-TDS      | PG-TDSON-8-U08 |  |  |  |  |  |
|----------------------------|-------------|----------------|--|--|--|--|--|
| DIMENSIONS                 | MILLIMETERS |                |  |  |  |  |  |
| DIMENSIONS                 | MIN.        | MAX.           |  |  |  |  |  |
| Α                          | 0.90        | 1.20           |  |  |  |  |  |
| b                          | 0.34        | 0.54           |  |  |  |  |  |
| С                          | 0.15        | 0.35           |  |  |  |  |  |
| D                          | 4.80        | 5.35           |  |  |  |  |  |
| D1                         | 3.90        | 4.40           |  |  |  |  |  |
| D2                         | 0.00        | 0.22           |  |  |  |  |  |
| E                          | 5.70        | 6.10           |  |  |  |  |  |
| E1                         | 4.05        | 4.25           |  |  |  |  |  |
| е                          | 1.27        |                |  |  |  |  |  |
| L                          | 0.45        | 0.65           |  |  |  |  |  |
| L1                         | 0.45        | 0.65           |  |  |  |  |  |

- 1) EXCLUDING MOLD FLASH
- 2) REMOVAL ON MOLD GATE INTRUSION 0.1 MM PROTRUSION 0.1 MM
- 3) ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

Figure 1 Outline PG-TDSON-8, dimensions in mm



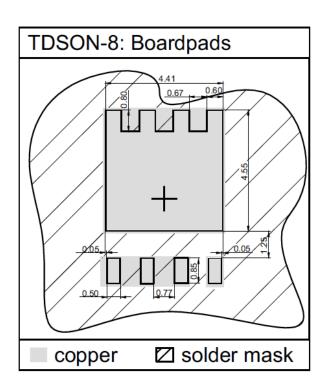
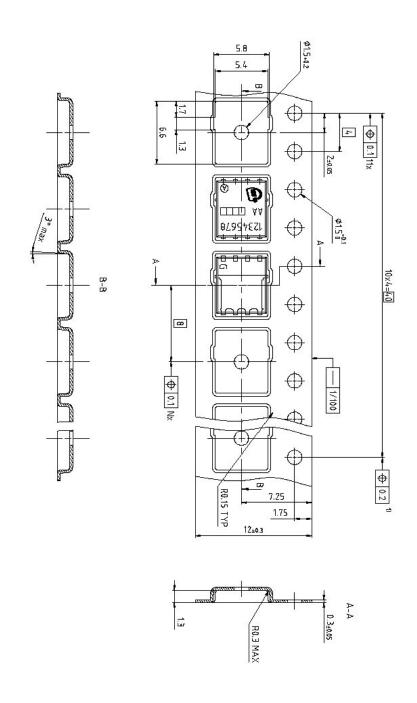


Figure 2 Outline Footprint (TDSON-8)





Dimension in mm

Figure 3 Outline Tape (TDSON-8)

# OptiMOS<sup>™</sup> 3 Power-Transistor, 120 V





#### **Revision History**

BSC0302LS

Revision: 2022-09-21, Rev. 2.2

Previous Revision

| Flevious Revision |            |  |  |  |  |  |  |
|-------------------|------------|--|--|--|--|--|--|
| Revision          | Date       | Subjects (major changes since last revision)             |  |  |  |  |  |
| 2.0               | 2019-12-02 | Release of final version                                 |  |  |  |  |  |
| 2.1               | 2022-08-09 | Update "Features", qualification, footnotes and fix bug. |  |  |  |  |  |
| 2.2               | 2022-09-21 | Update outline drawing                                   |  |  |  |  |  |

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